

AIM7E1AR60V1

Intelligent Power Module

External View



Features

- 600V-1A RC IGBT
- Fully functional 3-phase IGBT-IPM
- Reverse conducting IGBT with monolithic body diode
- · SMD package with exposed-pad
- Wide input interface (3-18V) with Schmitt-trigger input circuit
- Built-in bootstrap diodes with current-limiting resistor
- Control supply under-voltage lockout protection (UVLO)
- Over-temperature (OT) protection
- Short-circuit current protection
- Controllable fault out signal (VCF) corresponding to SC, UV, OT fault
- Isolation ratings of 1500Vrms/min

Applications

- AC 100~240Vrms low power motor drives
- Fan motors



Internal Equivalent Circuit







Ordering Information

Part Number	Package	Description
AIM7E1AR60V1	IPM-7A	N/A



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Pin Description

Pin Number	Pin Name	Pin Function			
1	V _{B(U)}	High-side control supply voltage for U-phase IGBT			
2	V _{B(V)}	High-side control supply voltage for V-phase IGBT			
3	V _{B(W)}	High-side control supply voltage for W-phase IGBT			
4	IN _(UH)	Control signal input for high-side U-phase			
5	IN(VH)	Control signal input for high-side V-phase			
6	IN _(WH)	Control signal input for high-side W-phase			
7	Vcc	Control supply voltage			
8	IN _(UL)	Control signal input for low-side U-phase			
9	IN(VL)	Control signal input for low-side V-phase			
10	IN(WL)	Control signal input for low-side W-phase			
11	Vcf	Controllable fault signal output			
12	СОМ	Common ground for control circuit			
13	Ν	Common Emitter for U/V/W-phase IGBTs connecting to short-circuit current protection input, which can sense short-circuit current through connecting a sensing resistor.			
14	U2	U-phase output 2. This pin should be connected to U1(pin 18)			
15	W	W-phase output			
16	V	V-phase output			
17	Р	DC-link bus positive input			
18	U1	U-phase output 1. This pin should be connected to U2(pin 14)			
19	Р	DC-link Bus positive input			



Absolute Maximum Ratings (T_J=25°C, unless otherwise specified)

Symbol	Parameter	Conditions	Ratings	Units
Inverter	•	•		
BV _{CES}	IGBT Breakdown Voltage	T _J =25°C	600	V
la.		Tc=25°C	1	Α
lc	IGBT Collector Current (Continuous)	T _C =80°C	0.5	Α
I _{CP}	IGBT Collector Current (Pulsed)	T _C =25°C, <100µs pulse width	1.5	Α
PD	Maximum Power Dissipation	per IGBT T _C =25°C	33.4	W
TJ	Operating Junction Temperature		-40 to 150	°C
Control (I	Protection)			
Vcc	Control Supply Voltage	Vcc-COM	-0.3 ~ 20	V
V _{BS}	High-side Control Supply Voltage	V _{B(U)} -U, V _{B(V)} -V, V _{B(W)} -W	-0.3 ~ 20	V
Vin	Control Signal Input Voltage	IN(UH), IN(VH), IN(WH), IN(UL), IN(VL), IN(WL)-COM	-0.3 ~ Vcc+0.5	V
Vcf	Fault Output Voltage	V _{CF} -COM	-0.3 ~ 5.5	V
Thermal I	Resistance			
R _{th(j-c)Q}	lunction to Coop Thermal Desistance	Single RC-IGBT	3.0	°C/W
Rth(j-c)F	Junction to Case Thermal Resistance	Single Diode	4.3	°C/W
Module				
Tc	Module Case Operation Temperature		-30 to 125	°C
Tstg	Storage Temperature		-40 to 150	°C
Viso	Isolation Voltage	60Hz, sinusoidal, AC 1min, between connected all pins and package top-center	1500	V _{rms}

Recommended Operation Conditions

Symbol	Parameter	Conditions	Min.	Тур.	Max	Units
V _{PN}	Bus Supply Voltage	VP-VN	0	300	450	V
Vcc	Control Supply Voltage	Vcc-COM	13.5	15.0	16.5	V
V _{BS}	High-side Control Supply Voltage	V _{B(U)} -U, V _{B(V)} -V, V _{B(W)} -W	13.5	15.0	16.5	V
dV _{cc} /dt, dV _{BS} /dt	Control Supply Voltage Variation		-1	-	1	V/µs
t _{dead}	Dead time	Control signals between high-side and low-side	1.5	-	-	μs
fрwм	PWM Input Frequency		-	16	-	kHz
PW _{IN(ON)}	Minimum Input Pulse Width	(Note 1)	0.7	-	-	μs
PWIN(OFF)			0.7	-	-	μs

Note:

1. IPM may not respond if the input pulse width is less than $PW_{IN(ON)}$, $PW_{IN(OFF)}$.



Electrical Characteristics (TJ=25°C, unless otherwise specified)

Symbol	Parameter	Conditions		Min.	Тур.	Max	Units
Inverter	•						
V _{CE(SAT)}	Collector-Emitter Saturation Voltage	$V_{CC}=V_{BS}=15V, V_{IN}=5V$	I _C =1A	-	2.0	2.6	V
VF	Emitter-Collector Forward Voltage	V _{CC} =V _{BS} =15V, V _{IN} =0 I _C =1A		-	2.4	2.9	V
t _{OFF}					1000	-	ns
t _f		VPN=300V, VCC=VBS=	-	90	-	ns	
ton	Switching Times	I _C =1A, V _{IN} =0V↔5V		-	600	-	ns
t _r		Inductive load (high-si	de)	-	50	-	ns
t _{rr}				-	210	-	ns
ICES	Collector-Emitter Leakage Current	VIN=0V, VCE=600V		-	-	1	mA
Control (Pr	otection)						
lacc	Quiescent V _{CC} Supply Current	Vcc=15V, IN(UL, VL, WL)=0V		-	-	1.5	mA
IQBS	Quiescent V _{BS} Supply Current	V _{BS} =15V, V _{B(U)} -U, V _{B(V)} -V, IN(UH, VH, WH)=0V V _{B(W)} -W		-	-	0.3	mA
UV _{CCT}	Trip Level		10.3	11.4	12.5	V	
UV _{CCR}	Supply Circuit Under-voltage	Reset Level			11.9	13.0	V
UVBST	Protection	Trip Level		9.0	10.0	11.0	V
UV _{BSR}		Reset Level		10.0	11.0	12.0	V
lin	Input Bias Current	Vin=5V		-	650	850	μA
$V_{\text{IN},\text{TH}(\text{ON})}$	ON Threshold Voltage	IN(UH), IN(VH), IN(WH), IN(UL), IN(VL), IN(WL) – COM		-	-	2.5	V
VIN,TH (OFF)	OFF Threshold Voltage			0.8	-	-	V
Vsc	Short-circuit Trip Level	Vcc=15V		0.9	1	1.1	V
OTT	Over-temperature Protection	Vcc=15V		110	130	150	°C
OTHYS		Hyster	esis of Trip Reset	-	30	-	°C
VCFH	Fault Output Voltage	V _N =0V		4.9	-	-	V
VCFL		V _N =1V		-	-	0.5	V
V _{CF+}	V _{CF} positive going threshold			-	1.9	2.2	V
V _{CF} -	V _{CF} negative going threshold			0.8	1.1	-	V
t _{FO}	Fault Output Pulse Width (Note 2)	When C_{CF} is not connected		20	-	-	μs
Bootstrap							
VF(BSD)	Bootstrap Diode Forward Voltage	IF=10mA including voltage drop by limiting		-	3.6	-	V
RBSD	Bootstrap Diode Equivalent Resistance	resistor	-	360	-	Ω	

Note:

 Fault output signal V_{CF} becomes low when one of protections OT, SC or UVLO is triggered. When failures happen like UV or OT, V_{CF} keeps low continuously until recovering from UV or OT state. 20µs indicates min. fault output duration time without pull-down capacitor. It can be controlled by the capacitor value as shown in Figure 1.



Functional Description

Controllable Fault Output Circuit



Figure 1. VCF Output Circuit

 V_{CF} pin provides an enable functionality that enables to shut down all low side IGBTs, besides it can be controlled with external MCU. When V_{CF} is in the high state, the IPM is able to operate normally. Meanwhile, V_{CF} is in a low state, the low-side IGBTs are turned off until V_{CF} recovers to the high state. In addition, the V_{CF} pin provides fixed or adjustable pulse width of fault output signal using external capacitor. If V_{CF} pin is left, the fault output pulse width t_{FO} is maintained as the low state for minimum 20us. If a capacitor is connected, the pulse width can be increased depending on to the capacitance.

The pulse width can be determined by the following formula;

$$t_{FO} = -(1M\Omega \cdot C_{CF}) \cdot ln\left(1 - \frac{V_{CF+}}{5V}\right) + 20usec$$

 $\approx 478 \mathbf{k} \cdot C_{CF} + 20 usec$

for example, adding C_{CF}=1nF, t_{FO}≈500us.

Short-Circuit (SC) Protection and Time Chart



Figure 2. Short-Circuit Protection



Adding shunt resistors between terminal N (Pin 13) and COM (Pin 12), SC protection can be operable. SC protection operational time chart can be described in Figure 2.

- (1) In normal operation, IGBT turns on and normal collector current $I_{\rm C}$ happens.
- (2) Once over current touches to SC trip level, SC protection is triggered.
- (3) All low-side IGBTs' gate are turned off. Accordingly, all low-side IGBTs are turned off.
- (4) Fault signal V_{CF} becomes from high to low and sustains low for t_{FO} (minimum 20µs).
- (5) V_{CF} recovers to high, normal operation restarts according to the input control signal.

Vcc Under-voltage Lock-out (UVLO) Protection and Time Chart



Figure 3. Under-Voltage Protection (Low-side, Vcc)

- (1) Supply voltage V_{CC} becomes higher than under-voltage reset level (UV_{CCR}), and IGBTs are turned on by the next ON signal.
- (2) Normal operation: IGBTs turn-on and output current.
- (3) V_{CC} level drops to under-voltage trip level (UV_{CCT}).
- (4) All low-side IGBTs are turned off regardless of control input condition.
- (5) V_{CF} output becomes low and stays as long as V_{CC} is below UV_{CCR} .
- (6) Once Vcc level reaches UVccR, IGBTs restart working normally according to the input control signal.



V_{BS} Under-voltage Lock-out (UVLO) Protection and Time Chart



Figure 4. Under-Voltage Protection (High-side, VBS)

- (1) Control supply voltage V_{BS} rises. After the voltage reaches under-voltage reset level (UV_{BSR}), IGBTs are turned on by the next ON signal.
- (2) Normal operation: IGBTs turn on and output current.
- (3) V_{BS} level drops to under-voltage trip level (UV_{BST}).
- (4) All high-side IGBTs are turned off regardless of control input condition.
- (5) V_{BS} level reaches UV_{BSR}.
- (6) Normal operation starts according to the input control signal.

Over Temperature (OT) Protection and Time Chart



Figure 5. Over-Temperature Protection

- (1) Normal operation: IGBTs turn on and output current.
- (2) LVIC temperature exceeds over-temperature trip level (OTT).
- (3) All low-side IGBTs are turned off regardless of control input condition.
- (4) V_{CF} output becomes low and stays as long as LVIC temperature is over OT_T .
- (5) LVIC temperature drops to over-temperature reset level (OT_{T-OTHYS}). Normal operation starts according to the input control signal.



Switching Time Definition





Typical Application Circuit and Design Guide





#1: Filter circuits for V_{CC} and V_{BS}

It is recommended that all capacitors are placed as close to the IPM as possible. C1 is recommended to electrolytic type with good temperature and frequency characteristics. C2 should be ceramic type with $0.1-2\mu$ F, good temperature, frequency and DC bias characteristics. A zener diode D1 (20V/1W) is recommended between each pair of control supply pins to avoid damage by external surge.



#2: Filter circuits for IN terminal

IN pins work with active-high and there is a minimum $3.5k\Omega$ pull-down resistor IPM inside. To prevent malfunction, the layout of each IN pins from MCU should be as short as possible. Recommended RC filter is 100ns of time constant, which can be adjusted considering amount of noise.

#3: Filter circuits for SC and V_{CF}

Selection of the R1*C4 filter components for short-circuit protection is recommended to have tight tolerance and temperaturecompensated type. The R1*C4 time constant should be set such that SC current is shut down within 2µs; (typically 1.5-2µs). R1 and C4 should be placed as close to N pin as possible. SC interrupting time may vary with layout patterns and components selections, therefore thorough evaluation in the system is necessary.

Capacitor C5 can adjust fault output pulse duration time V_{CF}. Without C5, V_{CF} has fixed minimum 20us pulse width. For the design guide, please refer to the Figure 1.

#4: Shunt resistance, GND layout and snubber capacitor

For designing a shunt resistor, it is recommended that short circuit trip level should be set less than 1.6 times of the rated current and the shunt resistor should be selected non-inductive and high accurate characteristic.

It is recommended to connect the control GND and power GND at a single point (N1) near the terminal of the shunt resistor. Control-related components such as V_{CC} , IN and V_{CF} should be connected to control GND and power-related components of C3 and dc-link capacitor should be connected to power GND to avoid noise interference from power GND to control GND.

The snubber capacitor C3 plays a role of absorbing high spike voltage on dc-link during switching operation so that it should be placed as close to pin P and pin N as possible. Generally a 0.1-0.22µF snubber capacitor is recommended.



Package Dimensions, IPM-7A





	DIMENSION IN MILLIMETRES			DIMENSION IN INCHS			
SYMBOLS	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	2.304	2.504	2.704	0.091	0.099	0.106	
A1	0.050	0.150	0.250	0.002	0.006	0.010	
A2	2.254	2.354	2.454	0.089	0.093	0.097	
A3	1.050	1.150	1.250	0.041	0.045	0.049	
D	17.800	17.900	18.000	0.701	0.705	0.709	
D1	1.960	2.060	2.160	0.077	0.081	0.085	
D2	6.620	6.720	6.820	0.261	0.265	0.269	
E	10.140	10.340	10.540	0.399	0.407	0.415	
E1	7.420	7.520	7.620	0.292 0.296 0.300			
E2	2.200	2.300	2.400	0.087	0.091	0.094	
L	0.505	0.705	0.905	0.020	0.028	0.036	
L1	1.210	1.410	1.610	0.048	0.056	0.063	
К	1.000	-	-	0.039	-	-	
е		1.270TYP			0.050TYP		
b		0.410TYP		0.016TYP.			
с	0.254TYP. 0.010TYP.						
θ1	7°TYP.			7°TYP.			
θ2	7°TYP.			7°TYP.			
θ3	0°		8°	0°	0° 8°		
θ4		45°TYP.		45°TYP.			
h	0.381TYP.			0.015TYP.			

NOTES

1. PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS, MOLD FLASH SHOULD BE LESS THAN 6 MIL.

UNIT: mm

2. TOLERANCE 0.100 MILLIMETERS UNLESS OTHERWISE SPECIFIED.

3. CONTROLLING DIMENSION IS MILLIMETER, CONVERTED INCH DIMENSIONS ARE NOT NECESSARILY EXACT.



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